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No.:

APPLICANT(s): Richard BARDSLEY

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EXAMINER:

TITLE: ELECTRONIC ASSEMBLY AND METHOD OF MANUFACTURE
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NO.: 871-011372-US(PAR) / 30011187 US-02

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

(37 C.F.R. §1.97(b)(1))

Sir:

This Information Disclosure Statement is filed together with the above-identified patent application. Thus, a certification under 37 C.F.R. 1.97 (e) or fee under 37 C.F.R. 1.17(p) is not required for the information herein to be considered.

The following information is being disclosed to the Patent and Trademark Office as information that may be material to the examination of the above-identified patent application.

The above-identified patent application claims priority to European Patent Application No. 02255317.6 filed July 30, 2002. Applicant's attorney encloses a copy of a European

Search Report issued on the priority European Patent Application No. 02255317.6. The Search Report cited the following documents: "A Package Design Technique For Size Reduction Of Implantable Bioelectronic Systems", Mani Soma, IEEE Transactions on Biomedical Engineering, Vol. 37, No. 5, 1990; "Preventing The Manhattan Effect", Anbe et al., Electronic Packaging And Production, Vol. 31, No. 2, 1991; and Patent Abstracts of Japan Publication Nos. JP 2001267351; JP 2001024144; JP 2001358167; JP 10199908; JP 09266124 and JP 01035905.

A copy of the European Search Report and the cited references are enclosed together with PTO-Form 1449.

The filing of this Statement is not to be construed as a representation that a search has been made regarding the claimed invention (37 C.F.R. §1.97(g)) or that no other possible material information exists. In addition, the filing of this Information Disclosure Statement is not to be construed to be an admission that the information cited in the Statement is, or is considered to be, material to patentability (37 C.F.R. §1.97(h)).

The Commissioner is hereby authorized to charge payment for any additional fees associated with this communication or credit any over payment to Deposit Account No. 16-1350.

Respectfully submitted,


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July 21, 2003

Date

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U.S. PATENTS						
Initials	Patent Number	Issue Date	Name	Class	Sub-class	Filing date
U.S. PATENT PUBLICATIONS						
Initials	Publication No.	Pub. Date	Name	Class	Sub-class	Filing Date
FOREIGN PATENT DOCUMENTS						
Initials	Document Number	Date	Country	Name	Translation? Yes/No/n/a	
OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)						
	"A Package Design Technique For Size Reduction Of Implantable Bioelectronic Systems", Mani Soma, IEEE Transactions on Biomedical Engineering, Vol. 37, No. 5, 1990.					
	"Preventing The Manhattan Effect", Anbe et al., Electronic Packaging And Production, Vol. 31, No. 2, 1991.					
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	Patent Abstracts of Japan Publication No. JP 10199908					
	Patent Abstracts of Japan Publication No. JP 09266124					
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